

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below under my name.

I believe that I am an original, sole and/or joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

COMPOUNDS FOR THE TREATMENT OF METABOLIC DISORDERS

the Specification of which

	is attached hereto	
X	was filed on	16 August 2004
X	as United States Application Number or PCT International Application No. PCT/US2004/026561	
	and was amended on	(if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified Specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any provisional application filed in the United States in accordance with 35 U.S.C. §1.119(e), or any application for patent that has been converted to a Provisional Application within one (1) year of its filing date, or any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

PRIOR FILED APPLICATION(S)

APPLICATION NUMBER	COUNTRY	(DAY/MONTH/YEAR FILED)	PRIORITY CLAIMED
60/496,533	US	20 August 2003	Yes

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application listed below:

APPLICATION NO.	FILING DATE (DAY/MONTH/YEAR)	STATUS - PATENTED, PENDING, ABANDONED
PCT/US2004/026561	16 August 2004	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF INVENTOR: **Shalini Sharma**

FULL RESIDENCE ADDRESS: **211 Bristol Downs Drive
Gaithersburg, Maryland 20877**

COUNTRY OF CITIZENSHIP: **United States of America**

FULL POST OFFICE ADDRESS: **same**

SIGNATURE OF INVENTOR Shalini Sharma

DATE 2/27/07

FULL NAME OF INVENTOR: **Reid W. von Borstel**

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Potomac, Maryland 20854**

COUNTRY OF CITIZENSHIP: **United States of America**

FULL POST OFFICE ADDRESS: **same**

SIGNATURE OF INVENTOR Reid von Borstel

DATE 22 February, 2007

FULL NAME OF INVENTOR: **Kirvin L. Hodge**

FULL RESIDENCE ADDRESS: **8115 Mississippi Road
Laurel, Maryland 20724**

COUNTRY OF CITIZENSHIP: **United States of America**

FULL POST OFFICE ADDRESS: **same**

SIGNATURE OF INVENTOR _____

DATE _____

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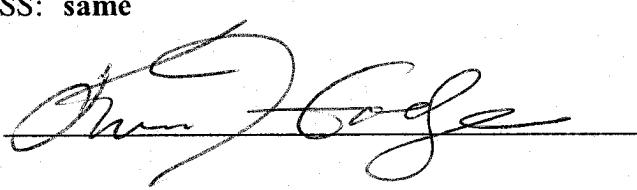
DATE _____

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FULL RESIDENCE ADDRESS: 8115 Mississippi Road
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COUNTRY OF CITIZENSHIP: United States of America

FULL POST OFFICE ADDRESS: same

SIGNATURE OF INVENTOR 

DATE 2/19/07